1-2199298-9 ACTIVE

DIPLOMATE

TE Internal #: 1-2199298-9

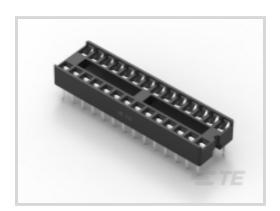
Stamped & Formed, 28 Position, Low Profile, Through Hole, Tin,

-40 - 105 °C [-40 - 221 °F], DIP Sockets

View on TE.com >



Connectors > Socket Connectors > IC Sockets > DIP Sockets > DIP Socket: Low Profile, Stamped & Formed, Open, Tin



Contact Fabrication: Stamped & Formed

Number of Positions: 28
Connector Profile: Low

Row-to-Row Spacing: 7.62 mm [.3 in]

Leg Style: Through Hole

All DIP Socket: Low Profile, Stamped & Formed, Open, Tin (6)

Features

Industry Standards

Termination Features

Termination Method to PCB	Through Hole - Solder
	3 in

Electrical Characteristics

Contact Resistance	20 mΩ
Insulation Resistance	1000 ΜΩ

Housing Features

Housing Color	Black
Housing Material	PBT GF30
Centerline (Pitch)	2.54 mm[.1 in]

Mechanical Attachment

Connector Mounting Type	Board Mount
Mating Alignment Type	Polarization
Mating Alignment	With

Packaging Features



ubes per Box	2
ackaging Method	Tube, Box & Tube
ackaging Quantity	17
peration/Application	
Circuit Application	Signal
her	
Quantity per Tube	1700
EU RoHS Compliance	Compliant
oduct Type Features	
Connector & Contact Terminates To	Printed Circuit Board
eg Style	Through Hole
mensions	
Product Length	35.56 mm[1.4 in]
rofile Height from PCB	5.1 mm[.2 in]
Row-to-Row Spacing	7.62 mm[.3 in]
ody Features	
leeve Plating Material	Tin/Lead
rame Style	Ladder
leeve Material	Brass/Copper
Connector Profile	Low
onfiguration Features	
CB Mount Orientation	Vertical
lumber of Rows	2
lumber of Positions	28
ontact Features	
Mating Contact Type	Dual Leaf
Contact Base Material	Phosphor Bronze
C Socket Type	DIP
CB Contact Termination Area Plating Material	Tin
Contact Type	Pin
Contact Fabrication	Stamped & Formed
Contact Mating Area Plating Material	Tin
ontact Mating Area Plating Material	1111



	60 μin
Contact Current Rating (Max)	1 A
Usage Conditions	
Operating Temperature Range	-40 - 105 °C[-40 - 221 °F]

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Out of Scope
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





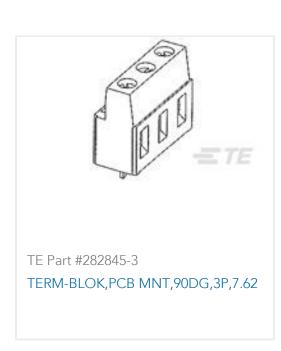




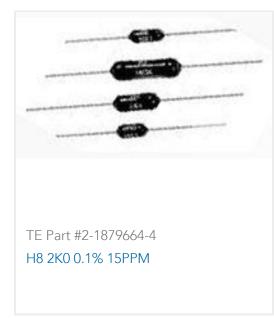
Customers Also Bought





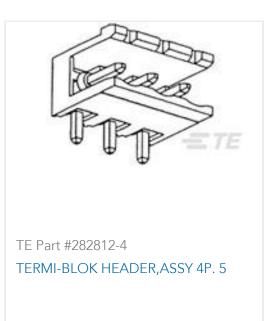


















Documents

Product Drawings

28P,DIP SKT,300 CL,LDR,PB FREE

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2199298-9_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-2199298-9_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-2199298-9_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

Stamped & Formed, 28 Position, Low Profile, Through Hole, Tin, -40 - 105 °C [-40 - 221 °F], DIP Sockets



DIP Sockets Quick Reference Guide (EN)

English